

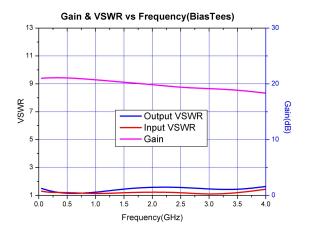
Low Noise Amplifier SG850

DESCRIPTION

SG850 is a high performance InGaP HBT MMIC amplifier utilizing a Darlington configuration with an active bias network. The active bias network provides stable current over temperature and process Beta variations. Designed to run directly from a 5V supply, the SG850 does not require a dropping resistor as compared to typical Darlington amplifiers. The SG850 product is designed for high linearity 5V gain block applications that require small size and minimal external components.

Major Applications

 Cable Modem •FTTH (G-PON, GE-PON) Optical node •IF & Driver Amplifier Cellular, PCS, GMS, UMTS •Wireless Data, Satellite Terminals



KEY FEATURES

- 0.05-4G, Cascadable
- Active Bias InGaP/GaAS HBT Amplifier
- Product Featuires:
- Wideband Flat Gain to4GHz
- IP3=40dBm@1218MHz •
- P1dB=23dBm@1218MHz
- Single +5V Supply
- 1000V ESD, Class IC
- MSL 1 moisture rating





ESD Class 1C

Appropriate precautions in handing, packaging and testing devices must be observed !



Pin Assignment

Pin	Function	Description
1	RF IN	RF input pin. This pin requires an external DC blocking capacitor.
2	GND	Connecting to ground. Use via holes for best performance to reduce lead inductance.
3	RF OUT / BIAS	RF output and bias pin. DC blocking capacitor is necessary for proper operating.



Typical RF Performance at Key Operating Frequencies

(With 45 ~ 1218MHz Application Circuit)

РА	RAMETER	UNIT	MIN	ТҮР	MAX	Condition
Frequency		MHz	45	-	1218	45MHz ~ 1218MHz
Gain		dB	-	20	-	45MHz ~ 1218MHz
Gain Flatness		dB	-	0.7	-	45MHz ~ 1218MHz
Input Return Loss		dB	-	-18	-	45MHz ~ 550MHz
			-	-12	-	550MHz ~ 1218MHz
Output Return Loss		dB	-	-18	-	45MHz ~ 550MHz
			-	-12	-	550MHz ~ 1218MHz
Noise Figure		dB	-	3	3.2	45MHz ~ 1218MHz
CSO	45 ~ 1218MHz	dBc	-	-	60	135 channel, +15dBmV/ch
СТВ		dBc	-	-	70	135 channel, +15dBmV/ch
XMOD		dBc	-	-	80	135 channel, +15dBmV/ch
DC Current		mA	-	80	-	Vdd = 5.0V

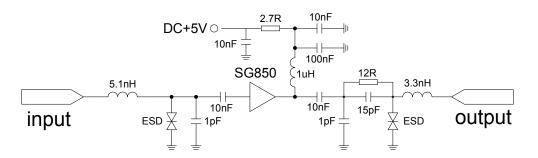
Important Note:

The information provided in this datasheet is deemed to be accurate and reliable only at present time. Sanland Technology Corp. reserves the right to make any changes to the specifications in this datasheet without prior notice.

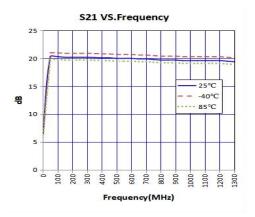


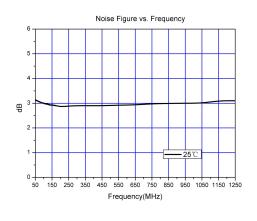
NOTE

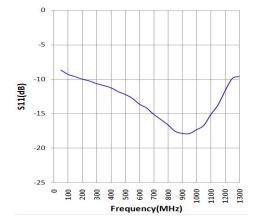
Test conditions: Test Freq = 550MHz, T=25°C, Vdd=5V, 75Ω system

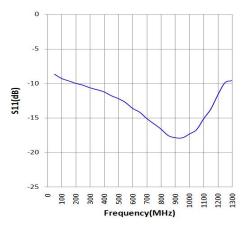


Data on Charts taken with 45MHz~1218MHz Application Circuit





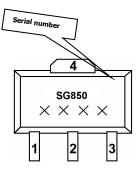




SG850



Marking and Pin Definition



Absolute Maximum Ratings

Parameter	Absolute Limit		
Max. Dvice Current (ID)	110 mA		
Max. Device Voltage (VD)	5.5V		
Max. RF Input Power	20 dBm		
Max. Junction Temp. (TJ)	+150°C		
Max. Operating Dissipated Power	0.66 W		
Operating Temp. Range (TL)	-40°C to +85°C		
Max. Storage Temp.	+150°C		
Operation beyond any one of cause permanent damage.	these limits may		

Mounting Instructions

- 1. Solder the copper pad on the backside of the device package to the ground plane.
- 2. Use a large ground pad area with many plated through-holes.
- Measurement for this data sheet is made on 0.5 mm thick FR-4 board with 3.38 dielectric constant

SOT89 Packaging

